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(12) **United States Design Patent** (10) **Patent No.:** **US D791,114 S**  
**Lee et al.** (45) **Date of Patent:** **\*\* Jul. 4, 2017**

(54) **COVER FOR ELECTRONIC COMMUNICATIONS DEVICE**

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(\*) Notice: This patent is subject to a terminal disclaimer.

(\*\*) Term: **14 Years**

(21) Appl. No.: **29/522,141**

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(30) **Foreign Application Priority Data**

Feb. 16, 2015 (KR) ..... 30-2015-0008454

(51) **LOC (10) Cl.** ..... **14-03**

(52) **U.S. Cl.**  
USPC ..... **D14/250**

(58) **Field of Classification Search**  
USPC ..... D14/238.1, 440, 203.3-203.7, 217, 240, D14/248, 251-253, 447, 496, 250;  
(Continued)

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(57) **CLAIM**

The ornamental design for a cover for electronic communications device, as shown and described.

**DESCRIPTION**

FIG. 1 is a top left front perspective view of a first embodiment of a cover for electronic communications device showing our new design;  
FIG. 2 is a front view thereof;  
FIG. 3 is a rear view thereof;  
FIG. 4 is a left-side elevation view thereof;  
FIG. 5 is a right-side elevation view thereof;  
FIG. 6 is a top plan view thereof;  
FIG. 7 is a bottom plan view thereof;  
FIG. 8 is an enlarged rear view of the area in FIG. 3 indicated by the lines A and B in FIG. 3 and also of the corresponding area in FIG. 13;  
FIG. 9 is an enlarged top right rear perspective view of the area in FIG. 3 indicated by the lines A and B in FIG. 3 and also of the corresponding area in FIG. 13;  
FIG. 10 is a top left front perspective view thereof, showing the first embodiment of a cover for an electronic device in an open position;  
FIG. 11 is a top left front perspective view of a second embodiment of a cover for an electronic device showing our new design;  
FIG. 12 is a front view thereof;  
FIG. 13 is a rear view thereof;  
FIG. 14 is a left-side elevation view thereof;  
FIG. 15 is a right-side elevation view thereof;  
FIG. 16 is a top plan view thereof;  
FIG. 17 is a bottom plan view thereof; and,  
FIG. 18 is a top left front perspective view thereof, showing the second embodiment of a cover for an electronic device in an open position.  
The dashed broken lines in the drawing figures depict portions of the cover for an electronic communications device that form no part of the embodiment of the claimed design in which they are shown. The dashed broken lines and unshaded areas bounded by dashed broken lines form no part of the embodiment of the claimed design in which they are shown.

(Continued)



The lines marked A and B in FIG. 3 indicate a portion of the first and second embodiments of the claimed design that is illustrated in enlargements and form no part of the claimed design.

The dot-dot-dash broken lines in FIGS. 8 and 9 delineate a portion of the first and second embodiments of the claimed design that is illustrated in enlargements and form no part of the claimed design.

**1 Claim, 13 Drawing Sheets**

(58) **Field of Classification Search**

USPC ..... D3/201, 218, 247, 269, 273, 301, 303;  
 D13/103, 107-108, 119  
 CPC H04B 1/3888; H04M 1/0283; H04M 1/0202;  
 A45C 1/06; A45C 2011/002; A45C 11/00;  
 A45C 13/02; A45F 2005/026; A45F  
 2200/0525; A45F 2200/0516  
 See application file for complete search history.

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FIG. 1

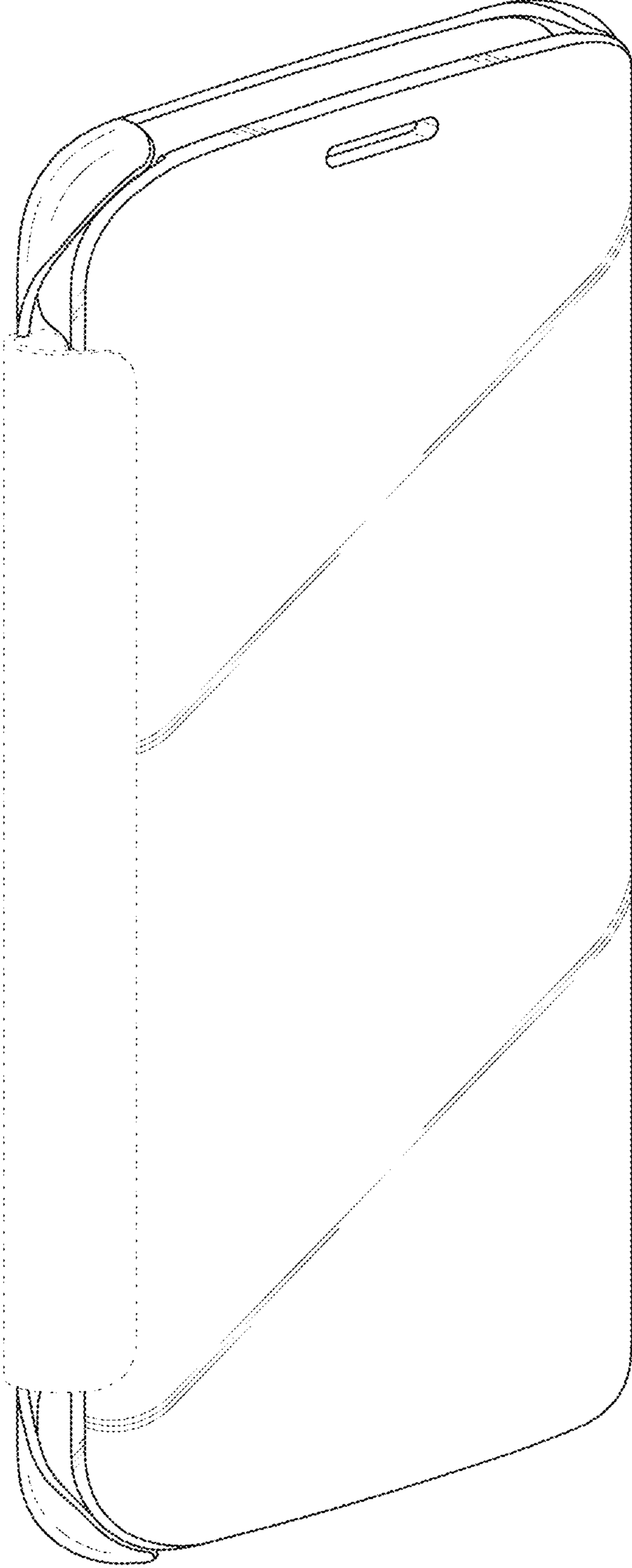


FIG.2

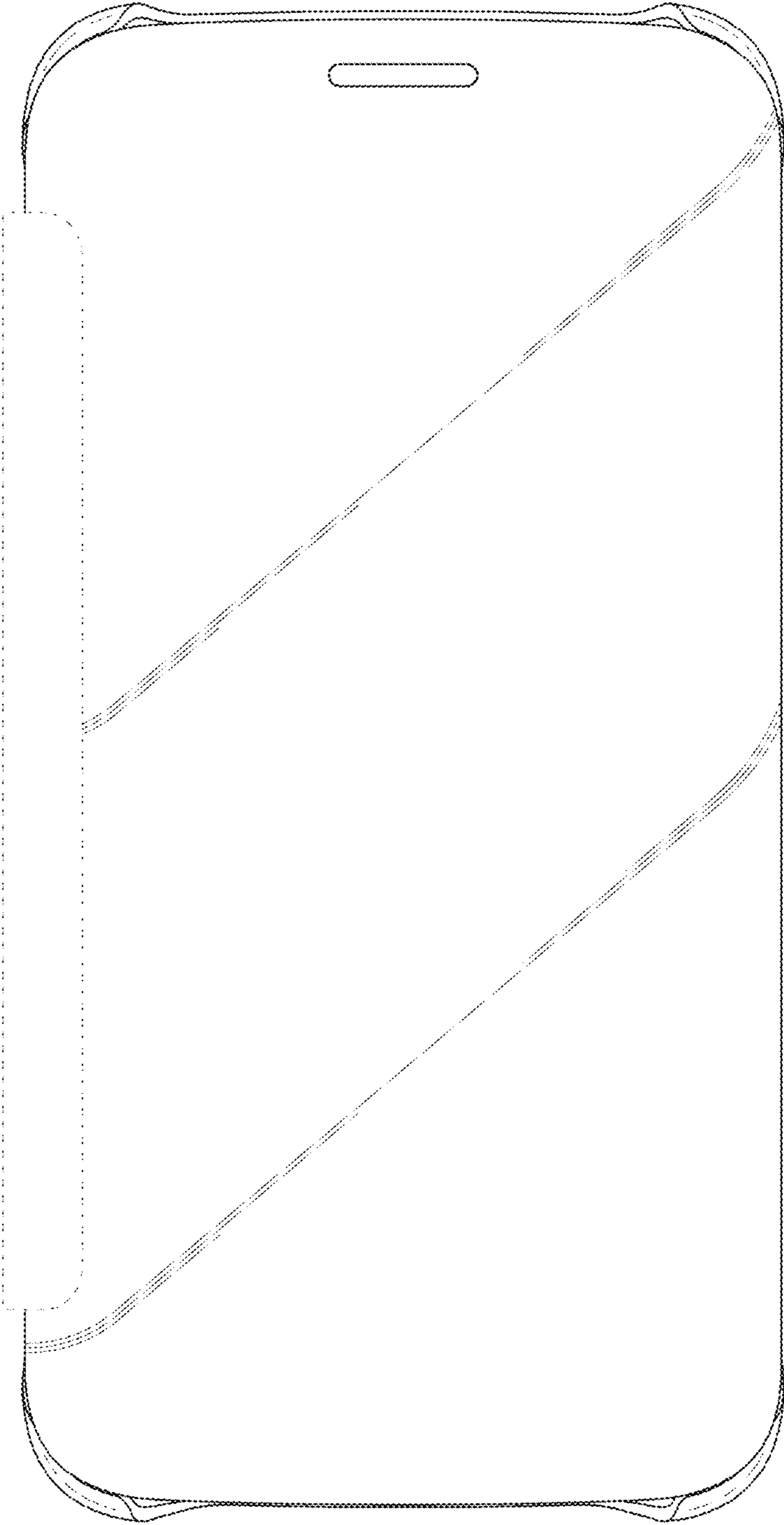


FIG.3

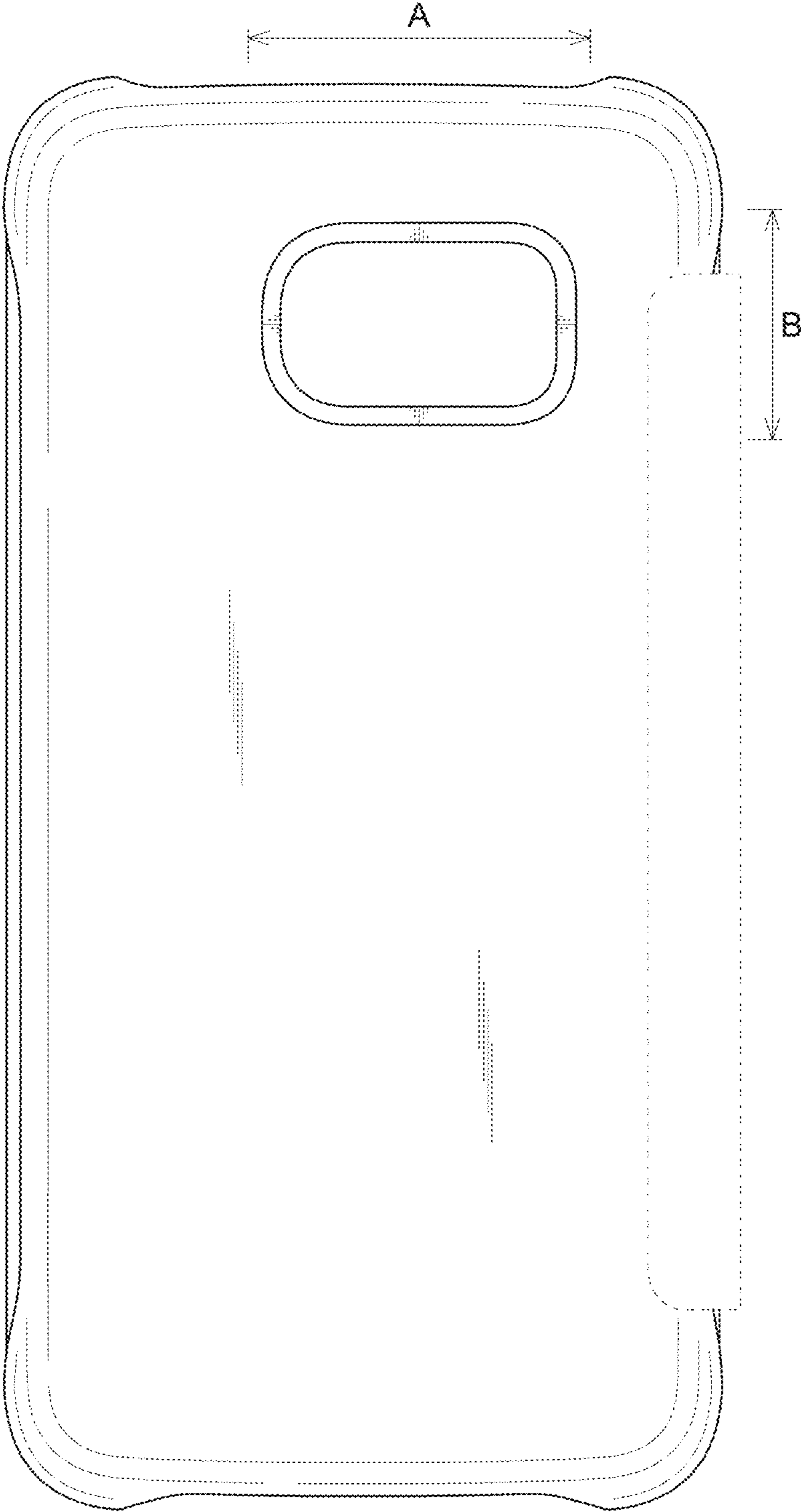


FIG.4

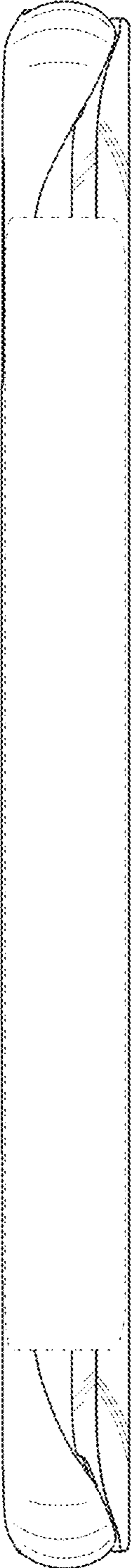


FIG.5

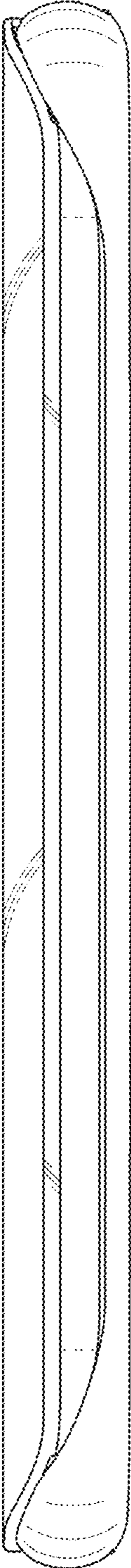


FIG.6

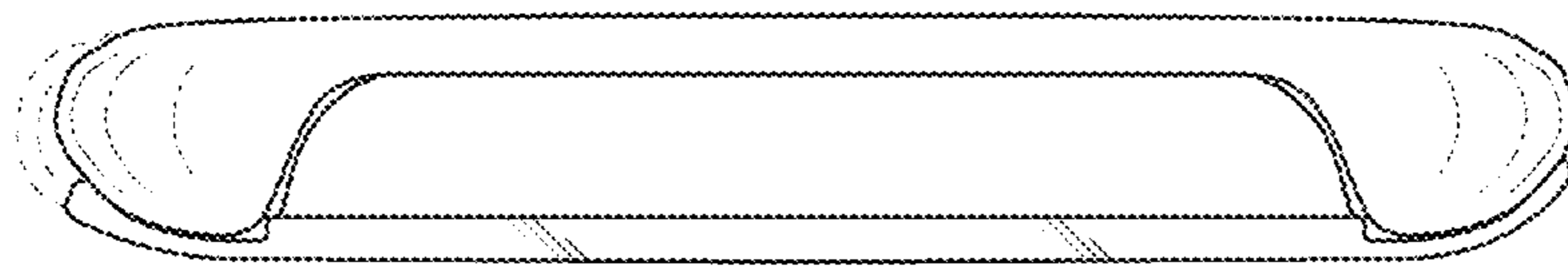


FIG.7

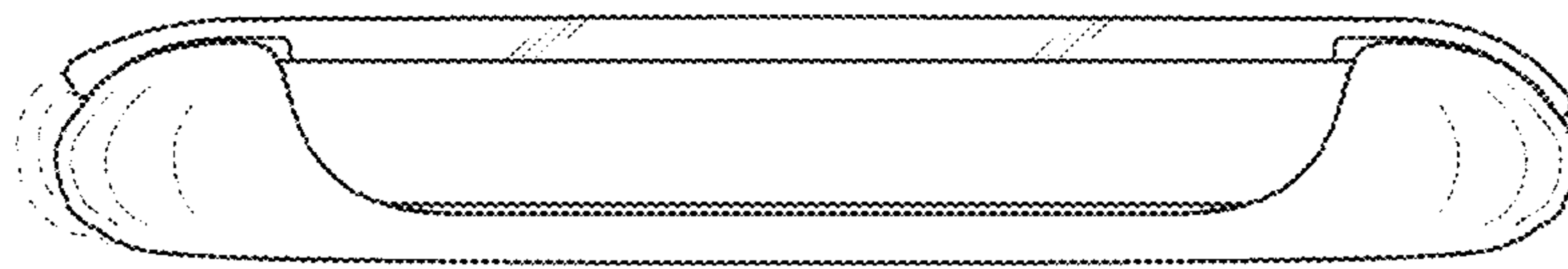


FIG.8

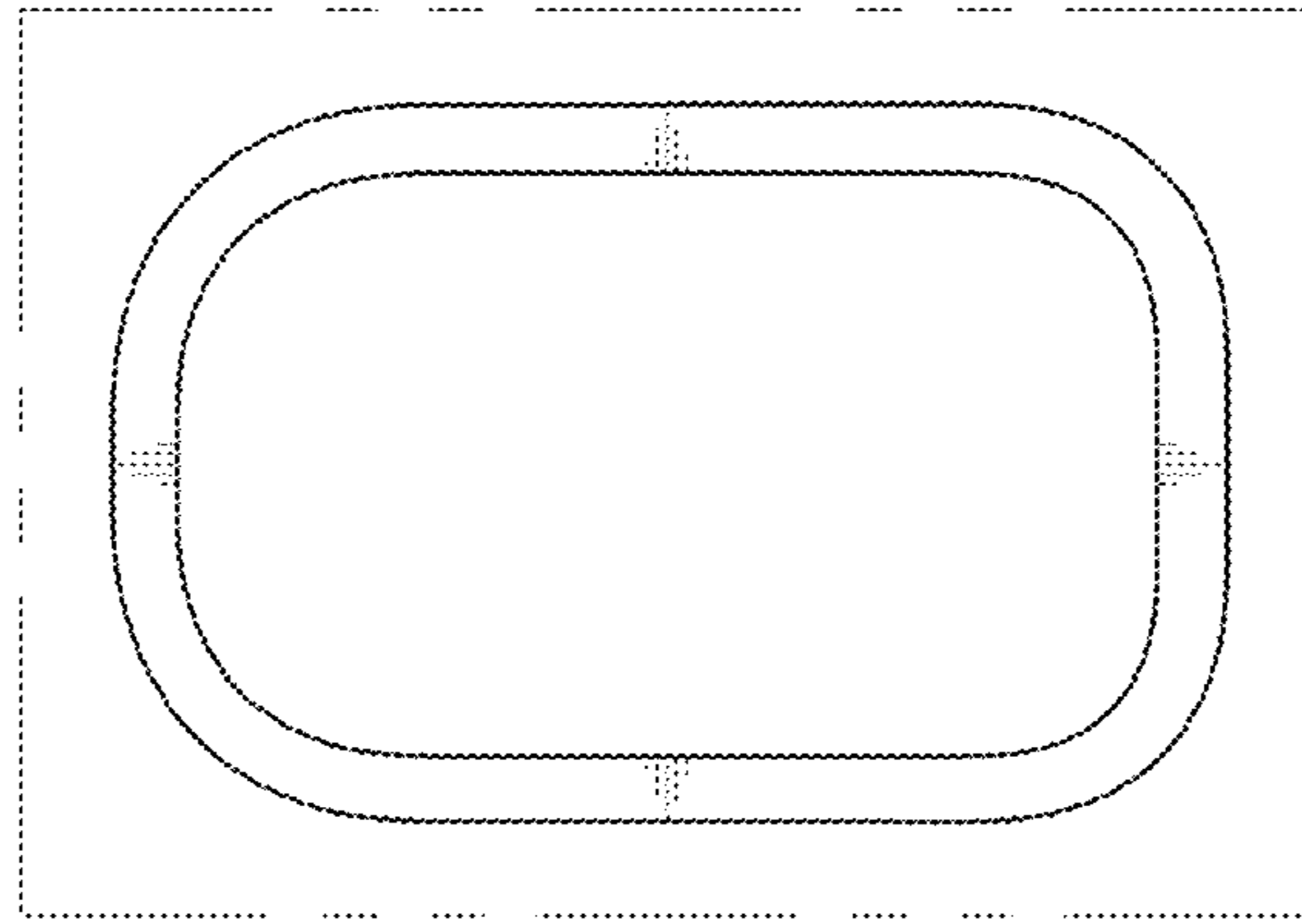


FIG.9

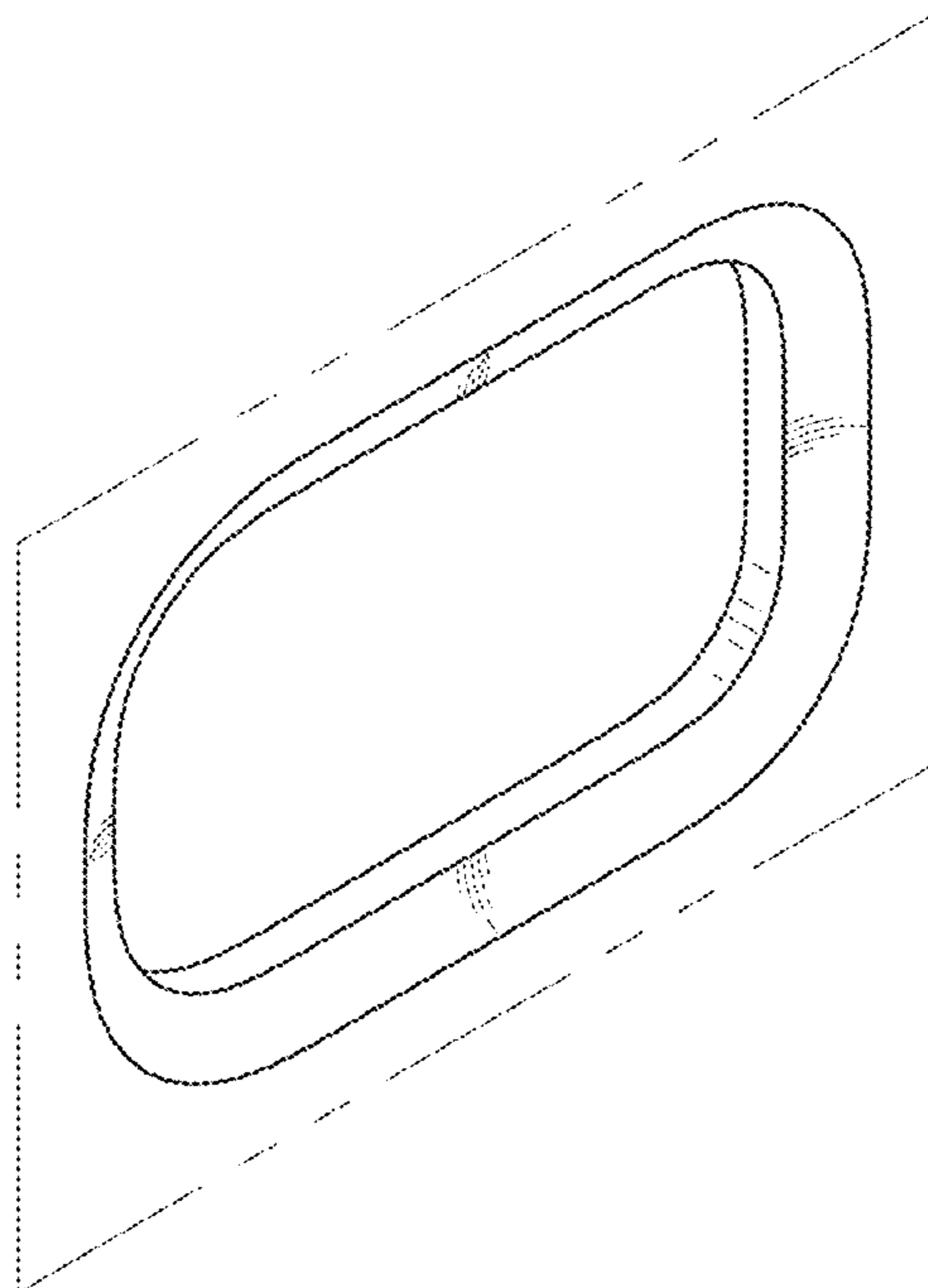




FIG. 10

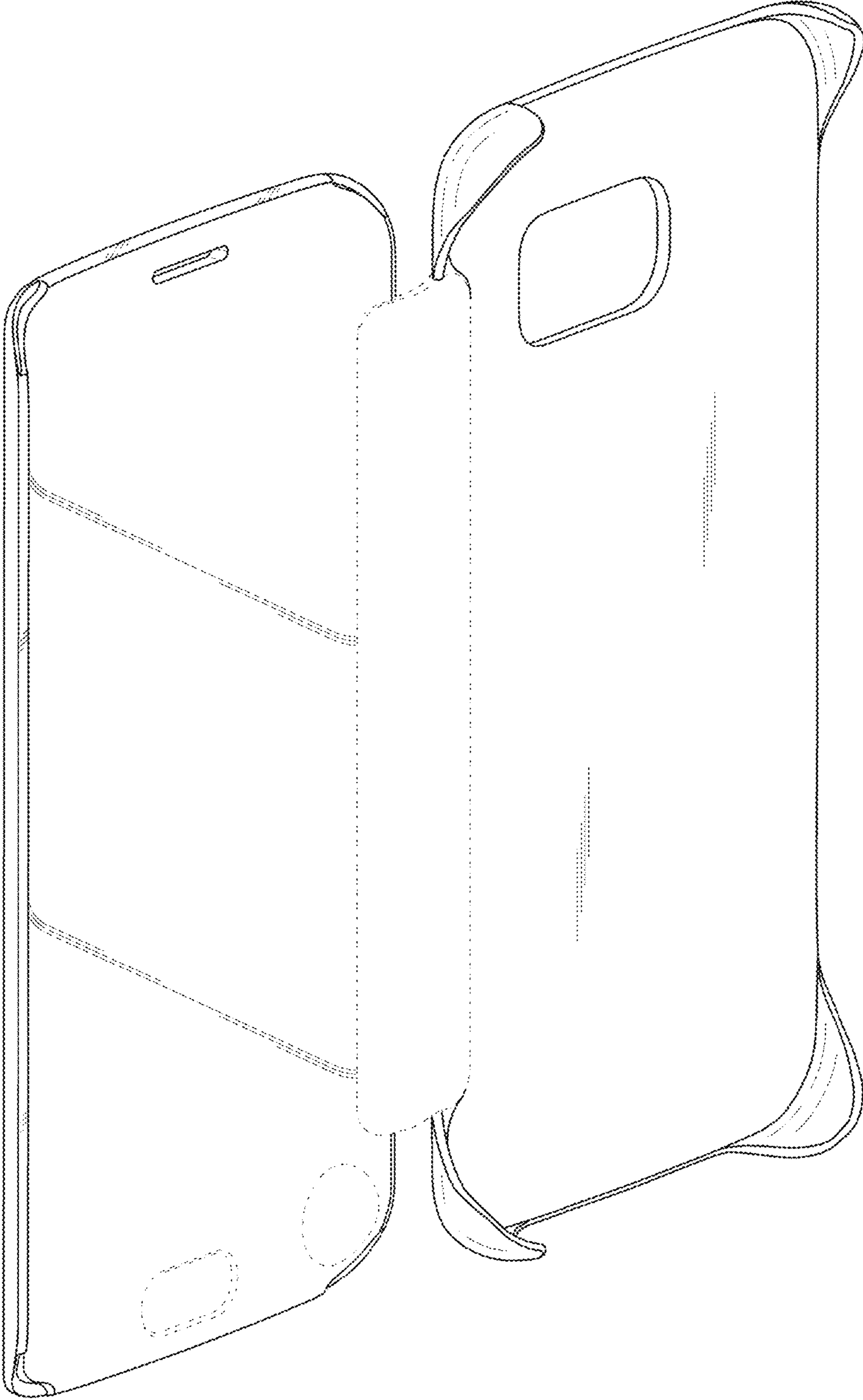


FIG. 11

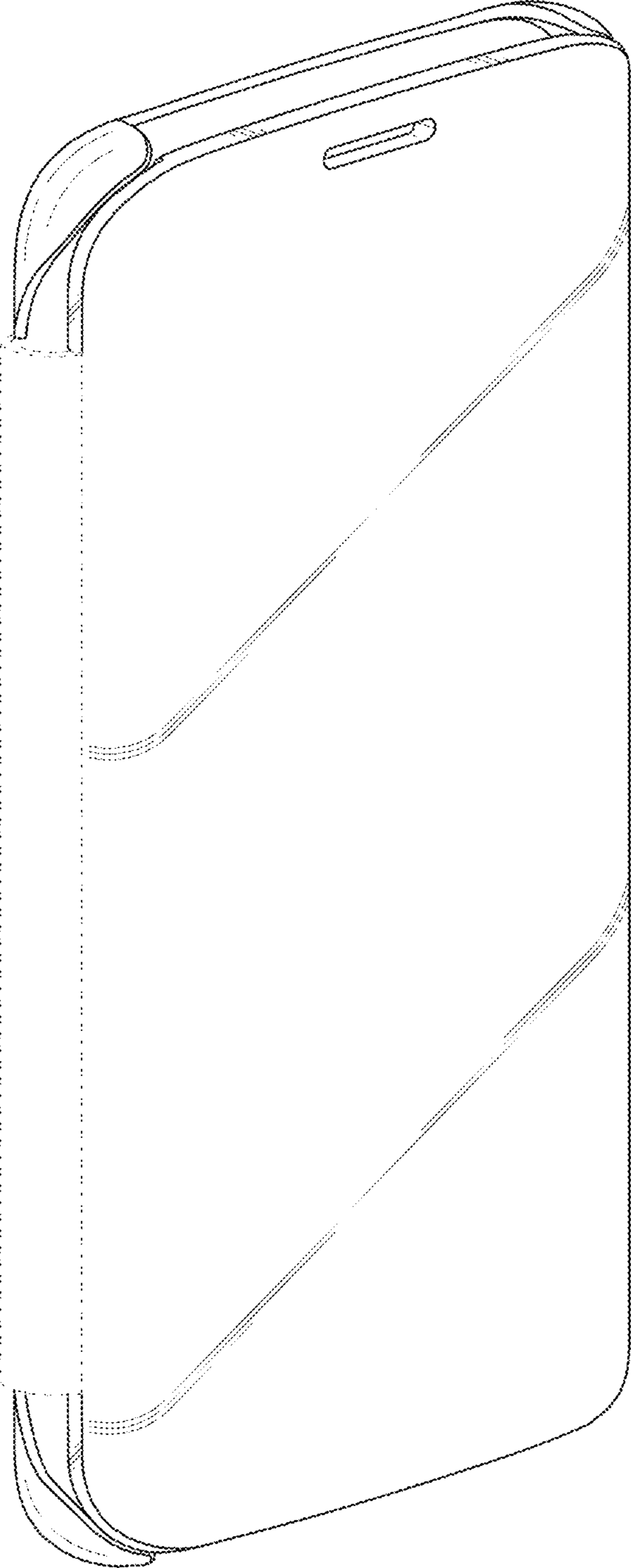


FIG.12

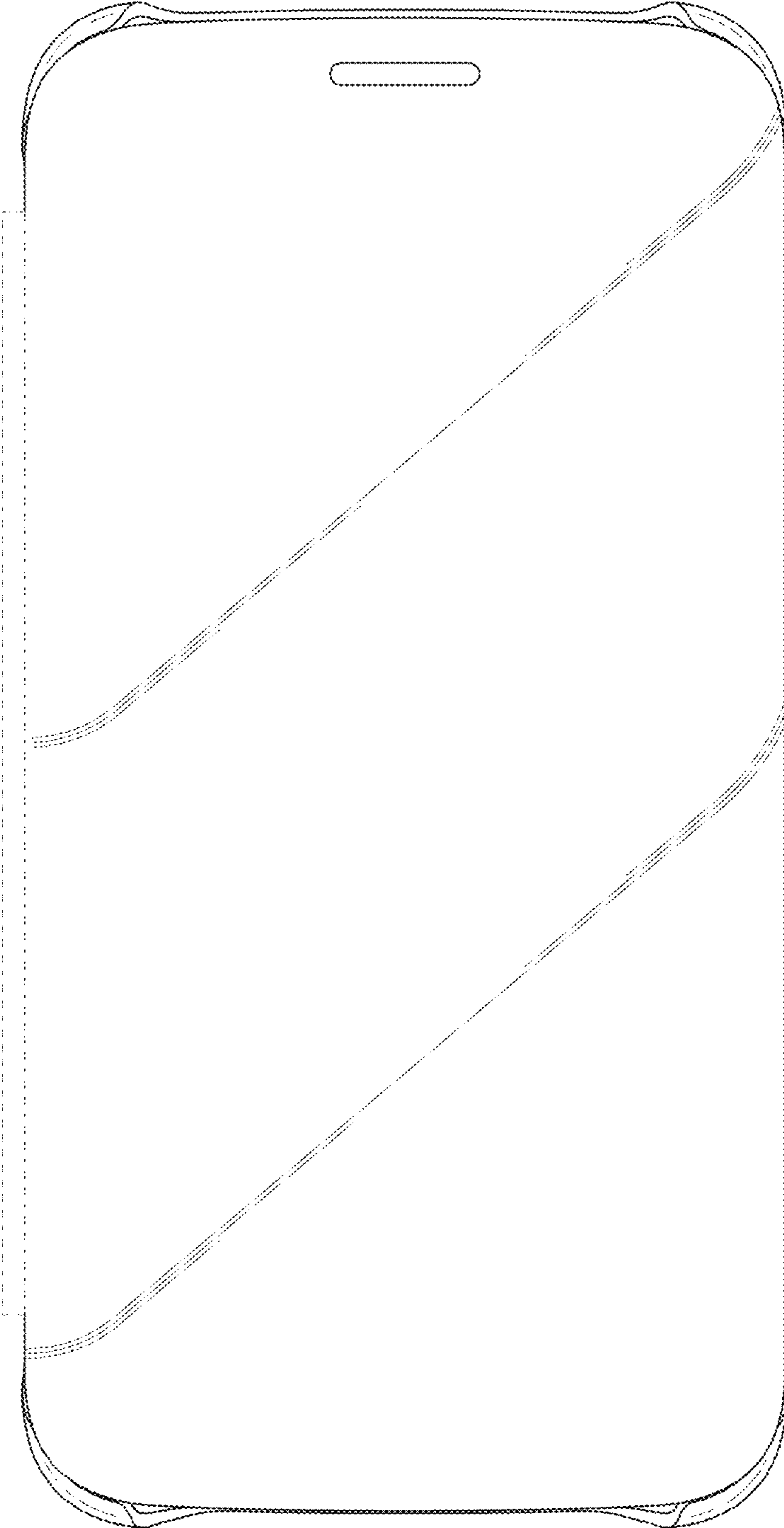


FIG. 13

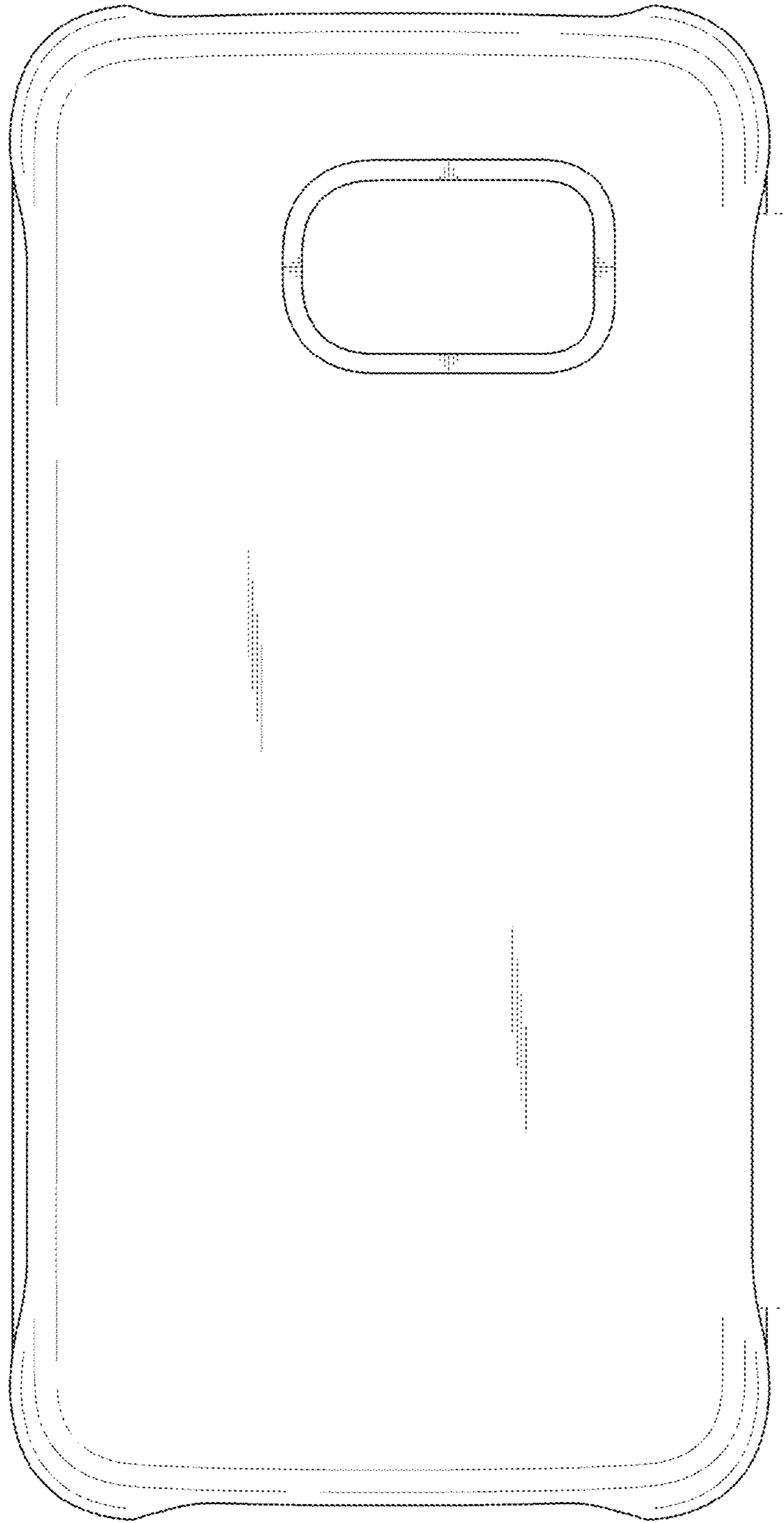


FIG.14

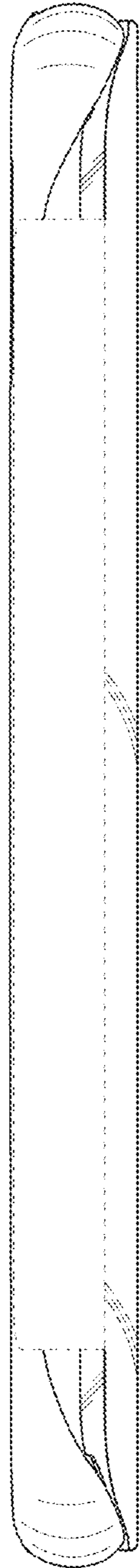


FIG.15

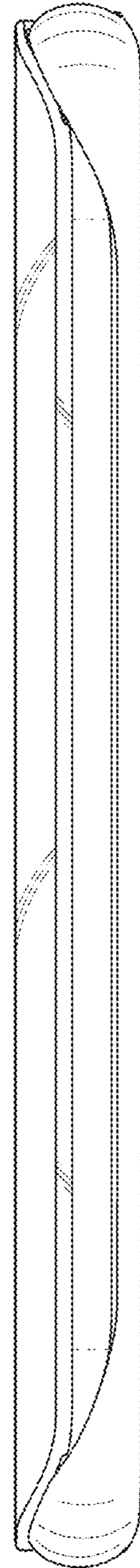


FIG.16

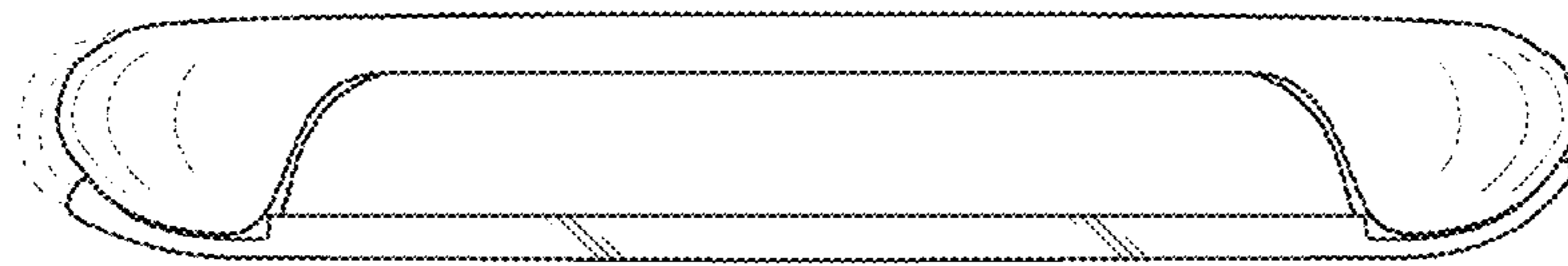


FIG.17

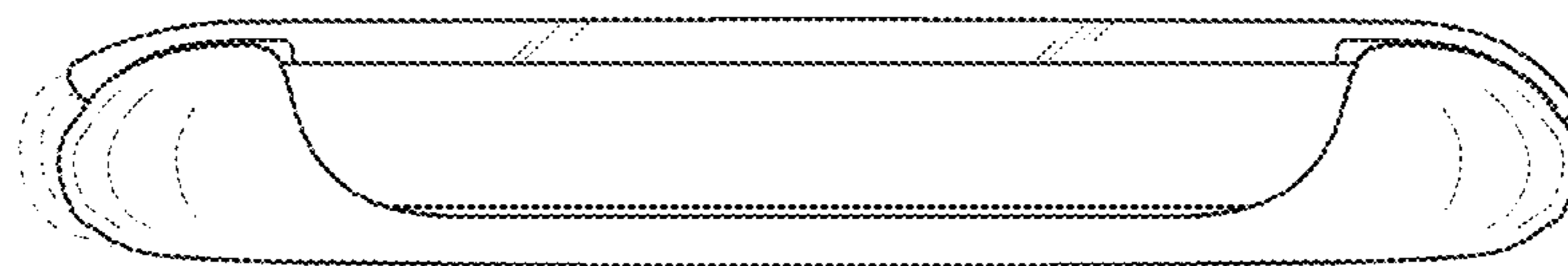


FIG. 18

